

August 2014

FDP51N25 / FDPF51N25 N-Channel UniFETTM MOSFET 250 V, 51 A, 60 m Ω

Features

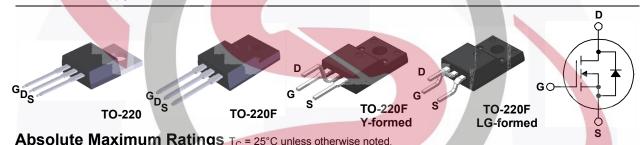
- $R_{DS(on)} = 48 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 25.5 \text{ A}$
- Low Gate Charge (Typ. 55 nC)
- Low C_{rss} (Typ. 63 pF)

Applications

- PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



Symbol	Para	ameter		FDP51N25	FDPF51N25 FDPF51N25YDTU FDPF51N25RDTU	Unit
V _{DSS}	Drain-Source Voltage			250		
I _D	Drain Current	- Continuous (T _C = - Continuous (T _C =	,	51 30	51* 30*	A A
I _{DM}	Drain Current	- Pulsed	(Note 1)	204	204*	Α
V _{GSS}	Gate-Source voltage			±	30	V
E _{AS}	Single Pulsed Avalanche Ene	ergy	(Note 2)	1	111	mJ
I _{AR}	Avalanche Current		(Note 1)		51	А
E _{AR}	Repetitive Avalanche Energy		(Note 1)		32	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)		1.5	V/ns
P _D	Power Dissipation	(T _C = 25°C) - Derate Above 25	°C	320 3.7	38 0.3	M\.c
T _{J,} T _{STG}	Operating and Storage Temp	erature Range		-55 t	o +150	°C
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300		°C

^{*}Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FDP51N25	FDPF51N25 FDPF51N25YDTU FDPF51N25RDTU	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.39	3.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W

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Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDP51N25	FDP51N25	TO-220	Tube	N/A	N/A	50 units
FDPF51N25	FDPF51N25	TO-220F	Tube	N/A	N/A	50 units
FDPF51N25YDTU	FDPF51N25	TO-220F (Y-formed)	Tube	N/A	N/A	50 units
FDPF51N25RDTU	FDPF51N25	TO-220F (LG-formed)	Tube	N/A	N/A	50 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit		
Off Charac	Off Characteristics							
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}, T_J = 25 ^{\circ}\text{C}$	250			V		
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	-	0.25		V/°C		
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 250 V, V _{GS} = 0 V V _{DS} = 200 V, T _C = 125°C	47		1 10	μA μA		
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA		
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0V			-100	nA		
On Charac	cteristics							
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		5.0	V		
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 25.5 A	\	0.048	0.060	Ω		
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 25.5 A		43	-	S		
Dynamic C	Characteristics							
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,	7-	2620	3410	pF		
C _{oss}	Output Capacitance	f = 1 MHz		530	690	pF		
C _{rss}	Reverse Transfer Capacitance			63	90	pF		
Switching	Characteristics							
t _{d(on)}	Turn-On Delay Time	V _{DD} = 125 V, I _D = 51 A,		62	135	ns		
t _r	Turn-On Rise Time	V_{GS} = 10 V, R_G = 25 Ω		465	940	ns		
t _{d(off)}	Turn-Off Delay Time			98	205	ns		
t _f	Turn-Off Fall Time	(Note 4)		130	270	ns		
Qg	Total Gate Charge	V _{DS} = 200 V, I _D = 51 A,		55	70	nC		
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		16	7	nC		
Q _{gd}	Gate-Drain Charge	(Note 4)		27	1	nC		
Drain-Source Diode Characteristics and Maximum Ratings								
Is	Maximum Continuous Drain-Source Dioc	de Forward Current	BT /	3 - N	51	A		
I _{SM} Maximum Pulsed Drain-Source Diode Fo		or <mark>ward C</mark> urrent		9-N	204	A		
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 51 A			1.4	V		
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 51 A,		178		ns		
Q _{rr}	Reverse Recovery Charge dI _F /dt =100 A/μs			4.0		μС		

Notes

- 1. Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. L = 0.68 mH, I $_{AS}$ = 51 A, V $_{DD}$ = 50 V, R $_{G}$ = 25 $\Omega,$ starting T $_{J}$ = 25 $^{\circ}C.$
- 3. $I_{SD} \le 51$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, starting $T_J = 25^{\circ}C$.
- 4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

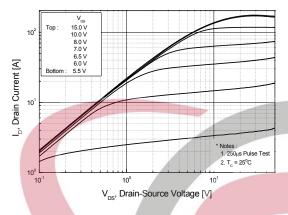


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

Figure 2. Transfer Characteristics

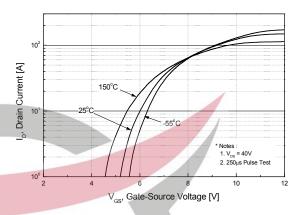


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

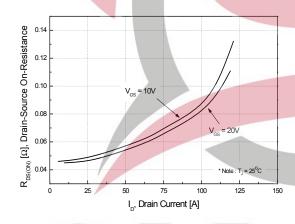


Figure 5. Capacitance Characteristics

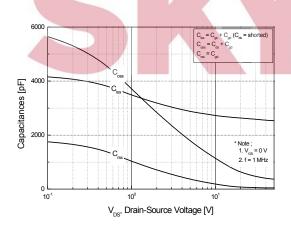
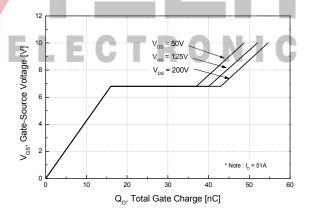


Figure 6. Gate Charge Characteristics

1.0

V_{sn}, Source-Drain voltage [V]

1.2



www.fairchildsemi.com

250μs Pulse Test

1.4

Drain Current [A]

Reverse

_ DR,

0.2

0.4

Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

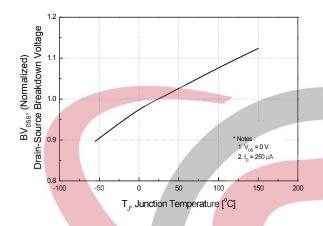


Figure 8. On-Resistance Variation vs. Temperature

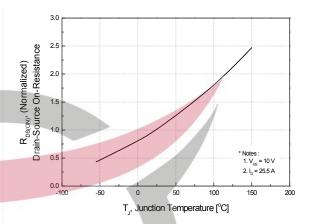
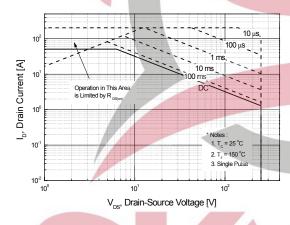


Figure 9-1. Maximum Safe Operating Area for FDP51N25

Figure 9-2. Maximum Safe Operating Area for FDPF51N25 / FDPF51N25YDTU



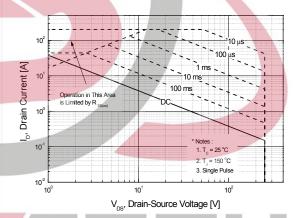
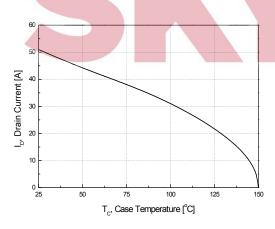


Figure 10. Maximum Drain Current vs. Case Temperature



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Typical Performance Characteristics (Continued)

Figure 11-1. Transient Thermal Response Curve for FDP51N25

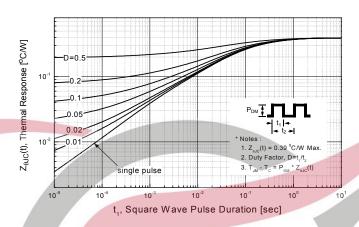
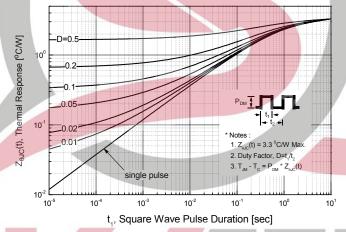


Figure 11-2. Transient Thermal Response Curve for FDPF51N25 / FDPF51N25YDTU



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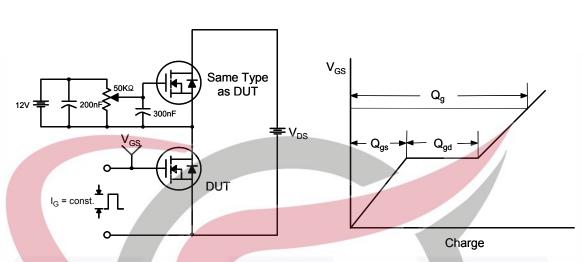


Figure 12. Gate Charge Test Circuit & Waveform

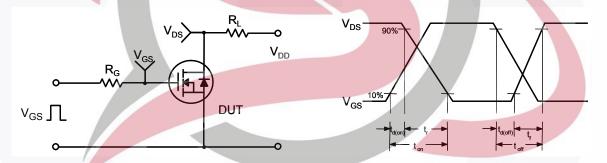


Figure 13. Resistive Switching Test Circuit & Waveforms

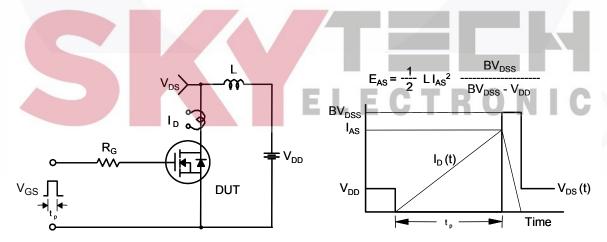
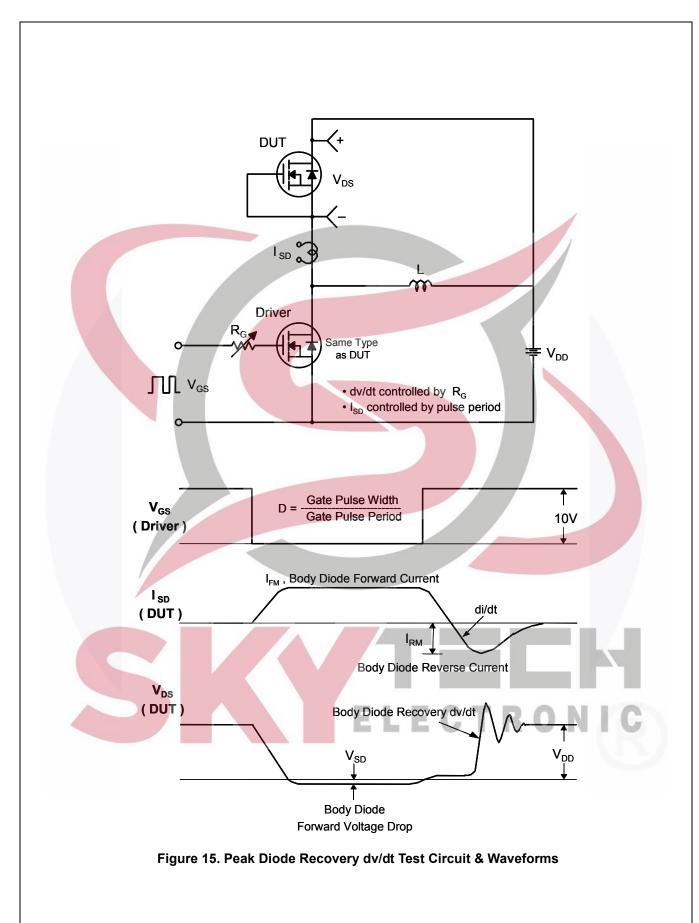
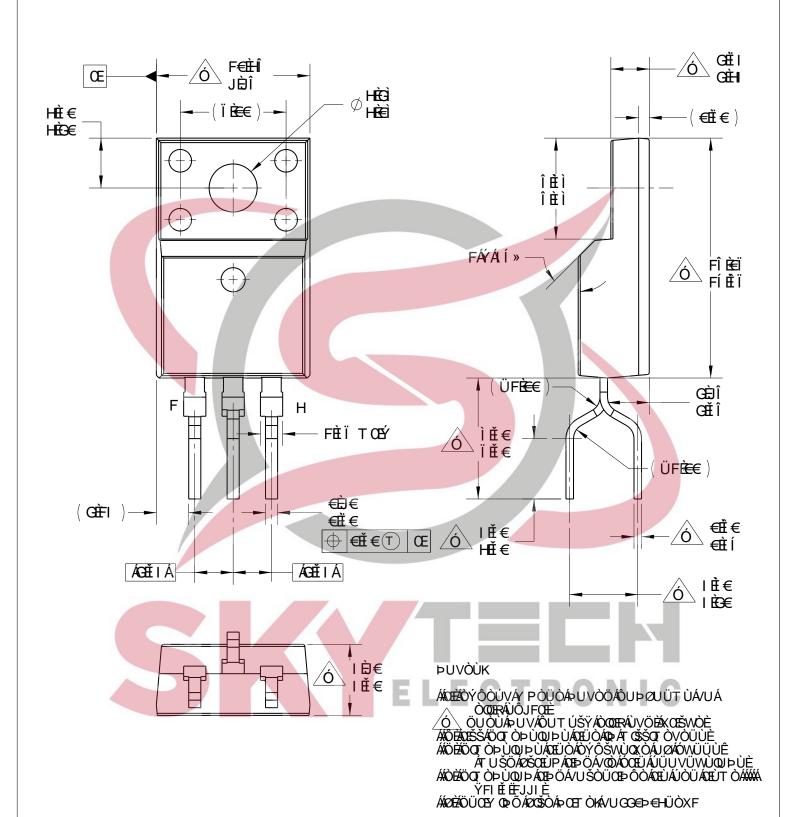


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

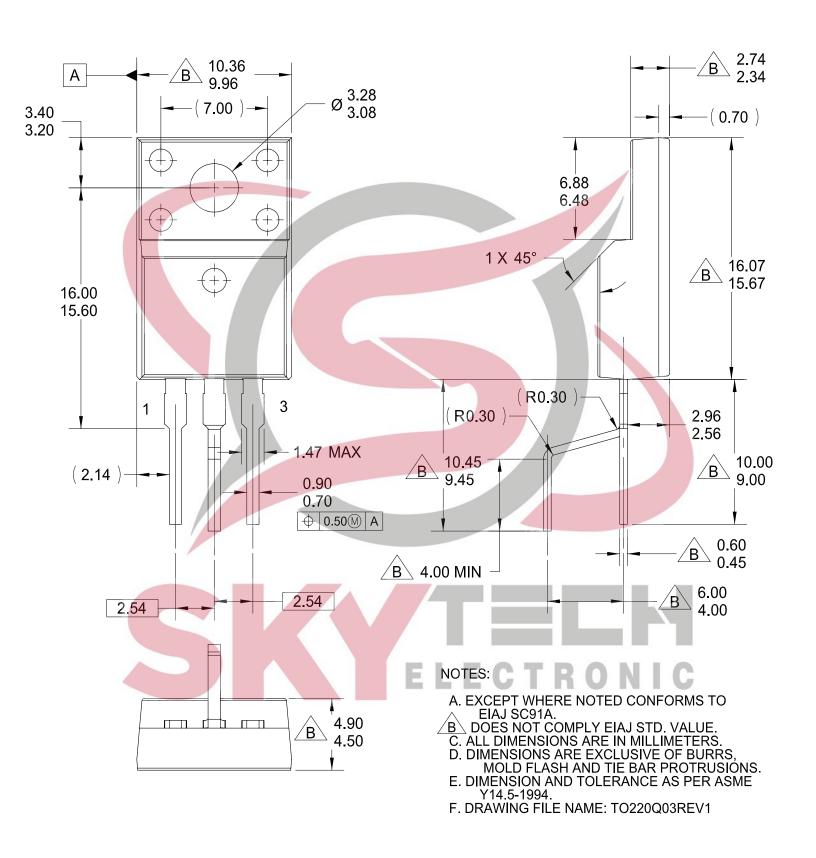


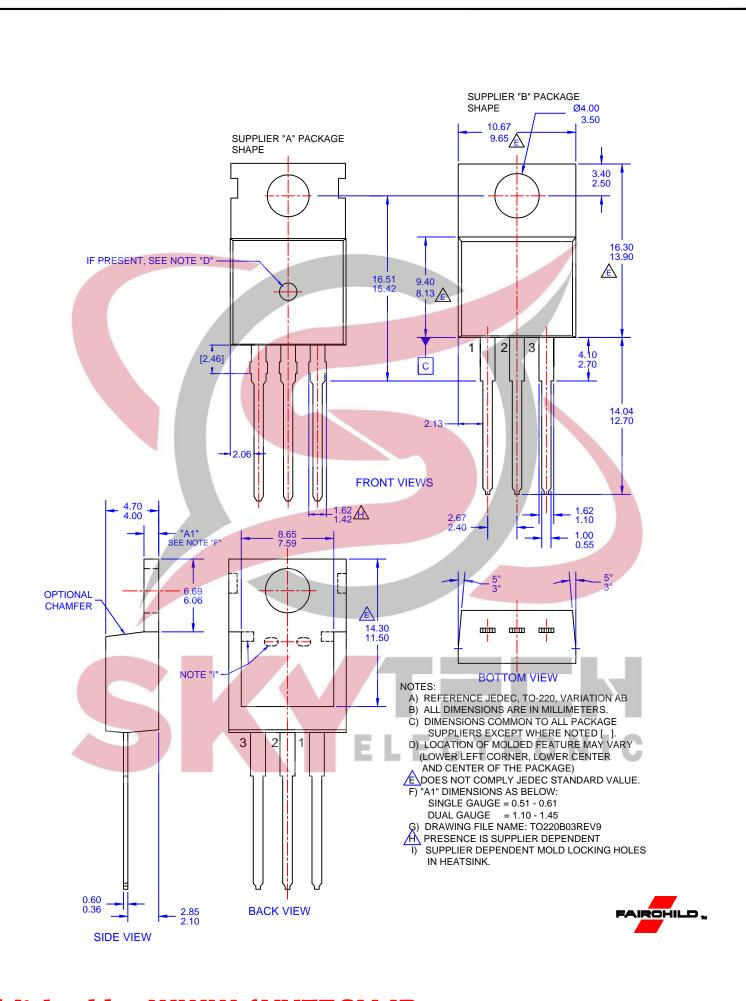


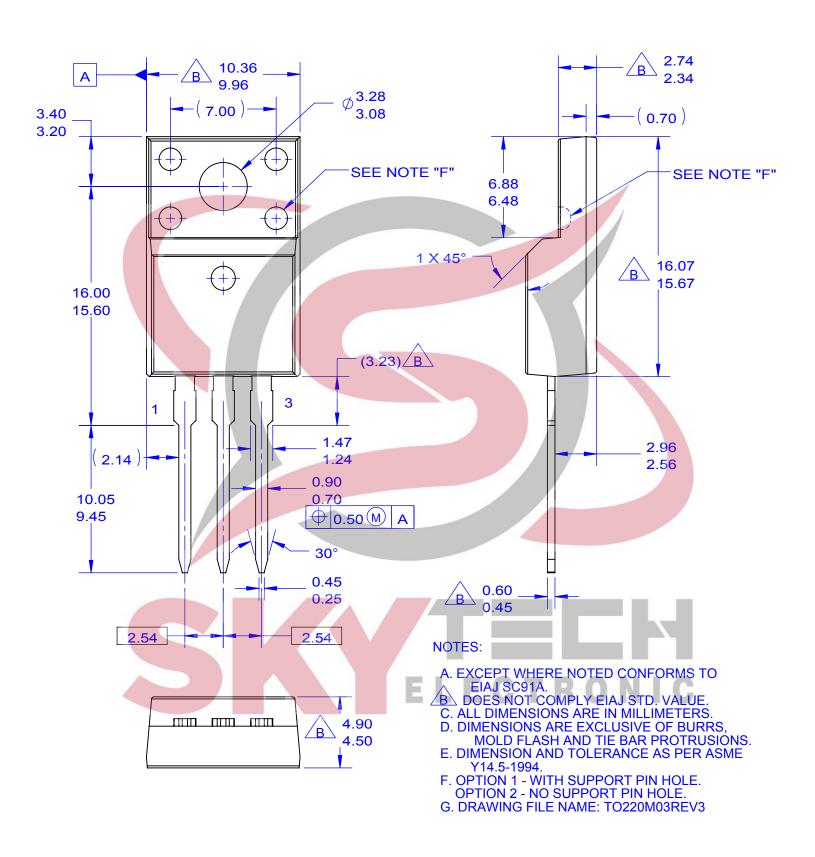
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Definition of Terms					
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